

#### FINAL PRODUCT/PROCESS CHANGE NOTIFICATION

Generic Copy

#### 21-MAR-2005

SUBJECT: ON Semiconductor Final Product/Process Change Notification #13984

TITLE: Final PCN for Qualification of VHVIC SOT-223 Products at ON Semiconductor, Seremban, Malaysia

**EFFECTIVE DATE: 21-May-2005** 

AFFECTED CHANGE CATEGORY(S): ON Semiconductor Assembly Site

AFFECTED PRODUCT DIVISION(S): Analog Products

**ADDITIONAL RELIABILITY DATA:** Available

Contact your local ON Semiconductor Sales Office or Ken Fergus <RRST50@onsemi.com>

**SAMPLES:** Contact your local ON Semiconductor Sales Office or Scott Brow FFTGCB@onsemi.com>

#### FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or Scott Brow <FFTGCB@onsemi.com>

## **NOTIFICATION TYPE:**

Final Product/Process Change Notification (FPCN)

Final change notification sent to customers. FPCNs are issued at least 60 days prior to implementation of the change.

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact your local ON Semiconductor Sales Office.

#### **DESCRIPTION AND PURPOSE:**

This is the Final Product Change Notification (follow up to IPCN 13513) to make customers aware that ON Semiconductor's internal assembly site in Seremban, Malaysia, is qualified to assemble ON Semiconductor's VHVIC SOT-223 products for increased capacity. These products are currently assembled at PSI Technologies in Manila, Philippines. Parts may be assembled at either of these sites upon expiration of this PCN.

Device parameters will continue to meet all Datasheet specifications, and reliability will continue to meet or exceed ON Semiconductor standards.

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### RELIABILITY DATA SUMMARY:

Reliability Test Results:

2 Lots of NCP1053ST136, 1 lot of NCP1014ST65

Test	Condition	Inte	erval	SS	Results
HTBB	TA=125C, Bias	504	hrs	3x80	0/240
HTB	TA=150C	1008	hrs	3x80	0/240
MSL1 PC	85C/85%,	168	hrs	9x80	0/720
	3 IR at 235C				
PCMSL1-TC	-65/+150C	1000	cycles	3x80	0/240
PCMSL1-Hast	TA=130C,RH=85%,	96	hrs	3x80	0/240
	Psig=18.8, bias				
PCMSL1-UHast	TA=130C,RH=85%,	96	hrs	3x80	0/240
	Psig=18.8, no bias				
MSL3 PC	30C/60%,	192	hrs	9x80	0/720
	3 IR at 260C				
PCMSL3-TC	-65/+150C	1000	cycles	3x80	0/240
PCMSL3-Hast	TA=130C,RH=85%,	96	hrs	3x80	0/240
	Psig=18.8, bias				
PCMSL3-UHast	TA=130C,RH=85%,	96	hrs	3x80	0/240
	Psig=18.8, no bias				

### **ELECTRICAL CHARACTERISTIC SUMMARY:**

Datasheet specifications remain unchanged.

#### **CHANGED PART IDENTIFICATION:**

Parts marked with date code after 0518 may be sourced from either site.

# AFFECTED DEVICE LIST (WITHOUT SPECIALS)

#### **PART**

NCP1010ST100T3

NCP1010ST130T3

NCP1010ST65T3

NCP1011ST100T3

NCP1011ST130T3

NCP1011ST65T3

NCP1011ST65T3G

NCP1012ST100T3

NCP1012ST100T3G

NCP1012ST130T3

NCP1012ST65T3

NCP1012ST65T3G

NCP1012XST100T3

NCP1013ST100T3

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NCP1013ST130T3

NCP1013ST65T3

NCP1014ST100T3

NCP1014ST100T3G

NCP1014ST65T3

NCP1014ST65T3G

NCP1050ST100T3

NCP1050ST100T3G

NCP1050ST136T3

NCP1050ST136T3G

NCP1050ST44T3

NCP1051ST100T3

NCP1051ST136T3

NCP1051ST44T3

NCP1052ST100T3

NCP1052ST100T3G

NCP1052ST136T3

NCP1052ST136T3G

NCP1052ST44T3

NCP1052ST44T3G

NCP1053ST100T3

NCP1053ST100T3G

NCP1053ST136T3

NCP1053ST136T3G

NCP1053ST44T3

NCP1054ST100T3

NCP1054ST136T3

NCP1054ST44T3

NCP1055ST100T3

NCP1055ST136T3

NCP1055ST44T3

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